TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (L^2 - π -MOSV)

2SK2614

Chopper Regulator, DC/DC Converter and Motor Drive Applications

• 4 V gate drive

• Low drain-source ON-resistance : $R_{DS(ON)} = 0.032 \Omega$ (typ.)

High forward transfer admittance : |Yfs| = 13S (typ.)
 Low leakage current : I_{DSS} = 100 µA (max) (V_{DS} = 50 V)
 Enhancement mode : V_{th} = 0.8~2.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Character	istic	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	50	V	
Drain-gate voltage (R _{GS} = 20 kΩ)		V_{DGR}	50	V	
Gate-source voltage		V_{GSS}	±20	V	
Drain current	DC (Note 1)	ΙD	20	Α	
	Pulse (Note 1)	I_{DP}	50	Α	
Drain power dissipation (Tc = 25°C)		P_{D}	40	W	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

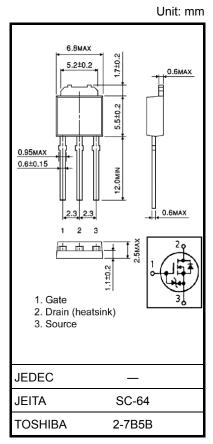
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

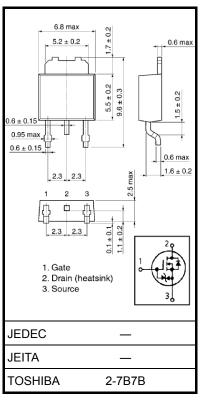
Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.125	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	125	°C/W

This transistor is an electrostatic-sensitive device. Handle with care.



Weight: 0.36 g (typ.)



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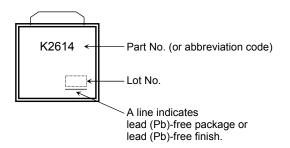
Electrical Characteristics (Ta = 25°C)

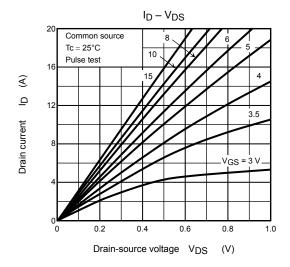
Charac	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cutoff curr	ent	I _{DSS}	V _{DS} = 50 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	50	_	_	V
Gate threshold v	oltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	_	2.0	V
Drain-source ON-resistance		D= 0 (01)	V _{DS} = 4 V, I _D = 5 A	_	0.055	0.08	Ω
		R _{DS} (ON)	V _{DS} = 10 V, I _D = 10 A	_	0.032	0.046	
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 10 A	7	13	_	S
Input capacitano	e	C _{iss}		_	900	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	130	_	pF
Output capacitance		C _{oss}		_	370	_	
Switching time	Rise time	t _r	V_{GS} $V_{DD} \approx 30$ V Duty ≤ 1%, $V_{W} = 10 \mu s$	_	15	_	ns
	Turn-on time	t _{on}		_	25	_	
	Fall time	t _f		_	30	_	
	Turn-off time	t _{off}		_	100	_	
Total gate charge (gate-source plus gate-drain) Gate-source charge Gate-drain ("Miller") charge		Qg	$V_{DD} \approx 40 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	_	25	_	nC
		Q _{gs}			19		
		Q _{gd}			6		

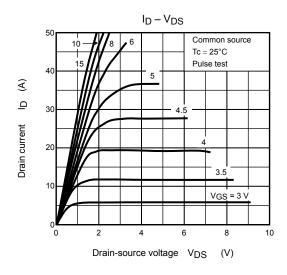
Source-Drain Ratings and Characteristics (Ta = 25°C)

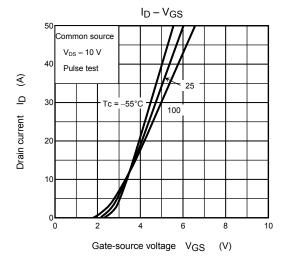
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	20	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	50	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 20 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	IDR = 20 A, V _{GS} = 0 V, dI _{DR} / dt = 50 A / µs	_	60	_	ns
Reverse recovery charge	Qrr	1DR - 20 A, VGS - 0 V, αIDR / αι - 50 A / μs		45	_	μC

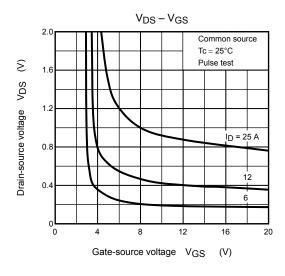
Marking

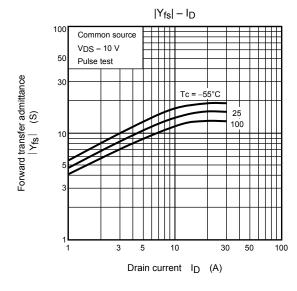


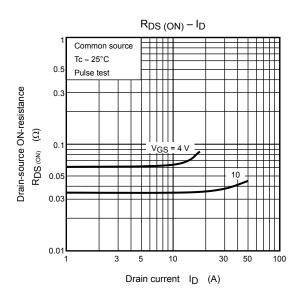




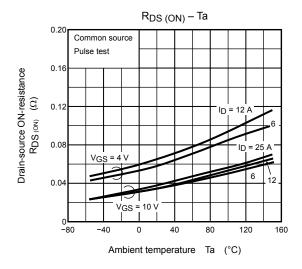


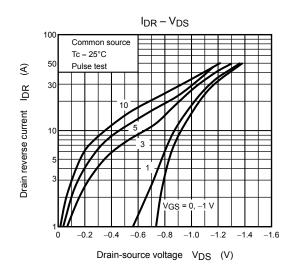


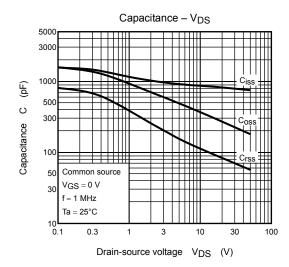


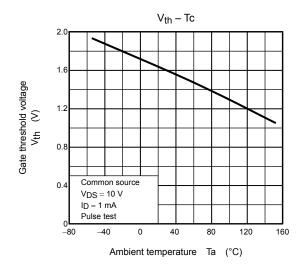


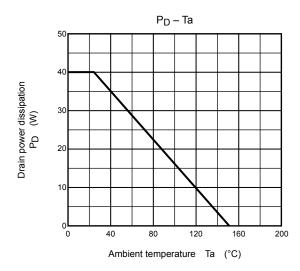
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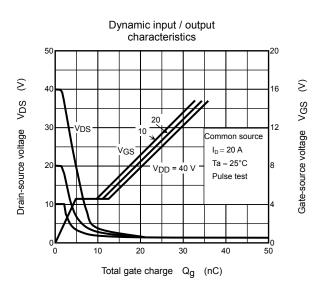


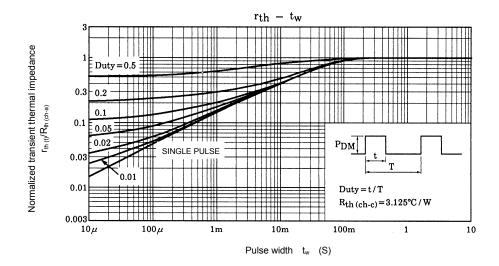


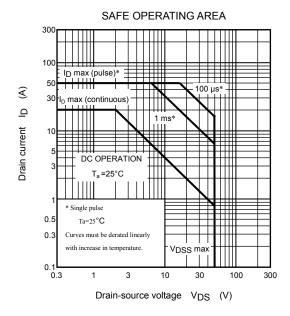












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